UCC2870x Constant-Voltage, Constant-Current Controller With Primary-Side Regulation

1 Features
- < 30-mW No-Load Power for 5-Star Rating
- Primary-Side Regulation (PSR) Eliminates Opto-Coupler
- ±5% Voltage and Current Regulation
- 130-kHz Maximum Switching Frequency Enables High-Power Density Charger Designs
- Quasi-Resonant Valley-Switching Operation for Highest Overall Efficiency
- Patent-Pending Frequency-Jitter Scheme to Ease EMI Compliance
- Wide VDD Range Allows Small Bias Capacitor
- Clamped Gate-Drive Output for MOSFET
- Protection Functions: Overvoltage, Low-Line, and Overcurrent
- Programmable Cable Compensation (UCC28700 Only)
- NTC Resistor Interface (UCC28701, UCC28702 and UCC28703 Only) With Fixed Cable Compensation Options
- SOT-23 Package

2 Applications
- USB-Compliant Adapters and Chargers for Consumer Electronics (Cell Phones, Tablets and Cameras)
- AC and DC Power Supplies

3 Description
The UCC28700 family of flyback power supply controllers provides Constant-Voltage (CV) and Constant-Current (CC) output regulation without the use of an optical coupler. The devices process information from the primary power switch and an auxiliary flyback winding for precise control of output voltage and current. Low start-up current, dynamically controlled operating states and a tailored modulation profile support very low standby power without sacriﬁcing start-up time or output transient response.

Control algorithms in the UCC28700 family allow operating efficiencies to meet or exceed applicable standards. The output drive interfaces to a MOSFET power switch. Discontinuous Conduction Mode (DCM) with valley switching reduces switching losses. Modulation of switching frequency and primary current peak amplitude (FM and AM) keeps the conversion efficiency high across the entire load and line ranges.

The controllers have a maximum switching frequency of 130 kHz and always maintain control of the peak-primary current in the transformer. Protection features help keep primary and secondary component stresses in check. The UCC28700 allows the level of cable compensation to be programmed. The UCC28701, UCC28702, and UCC28703 devices allow remote temperature sensing using a Negative Temperature Coefficient (NTC) resistor while providing fixed cable-compensation levels.

Device Information (1)

<table>
<thead>
<tr>
<th>PART NUMBER</th>
<th>PACKAGE</th>
<th>BODY SIZE (NOM)</th>
</tr>
</thead>
<tbody>
<tr>
<td>UCC28700</td>
<td>SOT-23</td>
<td>2.90 mm × 1.60 mm</td>
</tr>
<tr>
<td>UCC28701</td>
<td>SOT-23</td>
<td>2.90 mm × 1.60 mm</td>
</tr>
<tr>
<td>UCC28702</td>
<td>SOT-23</td>
<td>2.90 mm × 1.60 mm</td>
</tr>
<tr>
<td>UCC28703</td>
<td>SOT-23</td>
<td>2.90 mm × 1.60 mm</td>
</tr>
</tbody>
</table>

(1) For all available packages, see the orderable addendum at the end of the datasheet.
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4 Revision History

Changes from Original (July 2012) to Revision A

• Added Handling Rating table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section
5 Device Comparison Table

<table>
<thead>
<tr>
<th>PART NUMBER</th>
<th>VERSION</th>
</tr>
</thead>
<tbody>
<tr>
<td>UCC28700</td>
<td>Programmable cable compensation</td>
</tr>
<tr>
<td>UCC28701</td>
<td>NTC, 0 mV (at 5-V output) cable compensation option</td>
</tr>
<tr>
<td>UCC28702</td>
<td>NTC, 150 mV (at 5-V output) cable compensation option</td>
</tr>
<tr>
<td>UCC28703</td>
<td>NTC, 300 mV (at 5-V output) cable compensation option</td>
</tr>
</tbody>
</table>

(1) See Addendum for specific device ordering information.
(2) For other fixed cable compensation options, please consult the factory.

6 Pin Configuration and Functions

![Diagram of UCC28700/1/2/3 SOT-6 (DBV) with pin labels]

<table>
<thead>
<tr>
<th>PIN NAME</th>
<th>UCC28700 NO.</th>
<th>UCC28701/2/3 NO.</th>
<th>I/O</th>
<th>DESCRIPTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>CBC</td>
<td>1</td>
<td>—</td>
<td>I</td>
<td>Cable Compensation (CBC) is a programming pin for compensation of cable voltage drop. Cable compensation is programmed with a resistor to GND.</td>
</tr>
<tr>
<td>CS</td>
<td>4</td>
<td>4</td>
<td>I</td>
<td>Current Sense (CS) input connects to a ground-referenced current-sense resistor in series with the power switch. The resulting voltage is used to monitor and control the peak primary current. A series resistor can be added to this pin to compensate the peak switch current levels as the AC-mains input varies.</td>
</tr>
<tr>
<td>DRV</td>
<td>3</td>
<td>3</td>
<td>O</td>
<td>Drive (DRV) is an output used to drive the gate of an external high voltage MOSFET switching transistor.</td>
</tr>
<tr>
<td>GND</td>
<td>5</td>
<td>5</td>
<td>—</td>
<td>The Ground (GND) pin is both the reference pin for the controller and the low-side return for the drive output. Special care should be taken to return all AC decoupling capacitors as close as possible to this pin and avoid any common trace length with analog signal return paths.</td>
</tr>
<tr>
<td>NTC</td>
<td>—</td>
<td>1</td>
<td>I</td>
<td>NTC is an interface to an external NTC (negative temperature coefficient) resistor for remote temperature sensing. Pulling this pin low shuts down PWM action.</td>
</tr>
<tr>
<td>VDD</td>
<td>2</td>
<td>2</td>
<td>—</td>
<td>VDD is the bias supply input pin to the controller. A carefully-placed bypass capacitor to GND is required on this pin.</td>
</tr>
<tr>
<td>VS</td>
<td>6</td>
<td>6</td>
<td>I</td>
<td>Voltage Sense (VS) is an input used to provide voltage and timing feedback to the controller. This pin is connected to a voltage divider between an auxiliary winding and GND. The value of the upper resistor of this divider is used to program the AC-mains run and stop thresholds and line compensation at the CS pin.</td>
</tr>
</tbody>
</table>
7 Specifications

7.1 Absolute Maximum Ratings\(^{(1)}\)

<table>
<thead>
<tr>
<th></th>
<th>MIN</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>Bias supply voltage</td>
<td>(V_{VD})</td>
<td>38</td>
<td>V</td>
</tr>
<tr>
<td>Continuous gate current sink</td>
<td>(I_{DRV})</td>
<td>50</td>
<td>mA</td>
</tr>
<tr>
<td>Continuous gate current source</td>
<td>(I_{DRV})</td>
<td>Self-limiting</td>
<td></td>
</tr>
<tr>
<td>Peak VS pin current</td>
<td>(I_{VS})</td>
<td>−1.2</td>
<td></td>
</tr>
<tr>
<td>Voltage range</td>
<td>(V_{DRV})</td>
<td>−0.5</td>
<td>Self-limiting</td>
</tr>
<tr>
<td>Operating junction temperature range</td>
<td>(T_J)</td>
<td>−55</td>
<td>150 °C</td>
</tr>
<tr>
<td>Lead temperature 0.6 mm from case for 10 seconds</td>
<td>(T_{stg})</td>
<td>−65</td>
<td>150 °C</td>
</tr>
</tbody>
</table>

\(^{(1)}\) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. All voltages are with respect to GND. Currents are positive into, negative out of the specified terminal. These ratings apply over the operating ambient temperature ranges unless otherwise noted.

7.2 ESD Ratings

<table>
<thead>
<tr>
<th></th>
<th>VALUE</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>(V_{ESD}) Electrostatic discharge</td>
<td>Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001(^{(1)})</td>
<td>(±2000) V</td>
</tr>
<tr>
<td></td>
<td>Charged-device model (CDM), per JEDEC specification JESD22-C101(^{(2)})</td>
<td>(±500) V</td>
</tr>
</tbody>
</table>

\(^{(1)}\) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

\(^{(2)}\) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

<table>
<thead>
<tr>
<th></th>
<th>MIN</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>VDD</td>
<td>9</td>
<td>35</td>
<td>V</td>
</tr>
<tr>
<td>(C_{VD}) VDD bypass capacitor</td>
<td>0.047</td>
<td>1 µF</td>
<td></td>
</tr>
<tr>
<td>(R_{CBC}) Cable-compensation resistance</td>
<td>10 kΩ</td>
<td></td>
<td></td>
</tr>
<tr>
<td>(I_{VS}) VS pin current</td>
<td>−1 mA</td>
<td></td>
<td></td>
</tr>
<tr>
<td>(T_J) Operating junction temperature</td>
<td>−20</td>
<td>125 °C</td>
<td></td>
</tr>
</tbody>
</table>

These conditions apply over the operating free-air temperature range (unless otherwise noted).
7.4 Thermal Information

<table>
<thead>
<tr>
<th>THERMAL METRIC(1)</th>
<th>UCC2870x</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>θJA</td>
<td>180</td>
<td>°C/W</td>
</tr>
<tr>
<td>θJC(top)</td>
<td>71.2</td>
<td></td>
</tr>
<tr>
<td>θJB</td>
<td>44.4</td>
<td></td>
</tr>
<tr>
<td>ψJT</td>
<td>5.1</td>
<td></td>
</tr>
<tr>
<td>ψJB</td>
<td>43.8</td>
<td></td>
</tr>
</tbody>
</table>

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.
(2) The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a JEDEC-standard, high-K board, as specified in JESD51-7, in an environment described in JESD51-2a.
(3) The junction-to-case (top) thermal resistance is obtained by simulating a cold plate test on the package top. No specific JEDEC-standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.
(4) The junction-to-board thermal resistance is obtained by simulating in an environment with a ring cold plate fixture to control the PCB temperature, as described in JESD51-8.
(5) The junction-to-top characterization parameter, ψJT, estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining RθJA, using a procedure described in JESD51-2a (sections 6 and 7).
(6) The junction-to-board characterization parameter, ψJB, estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining RθJA, using a procedure described in JESD51-2a (sections 6 and 7).

7.5 Electrical Characteristics

over operating free-air temperature range, VDD = 25 V, RCBC = RNTC = open, −20°C ≤ TA ≤ 125°C, TJ = TA
(unless otherwise noted)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>BIAS SUPPLY INPUT</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>I RunI diagnostic I</td>
<td>Supply current, run</td>
<td>2.1</td>
<td>2.65</td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>I WaitI diagnostic I</td>
<td>Supply current, wait</td>
<td>85</td>
<td>110</td>
<td>µA</td>
<td></td>
</tr>
<tr>
<td>I StartI diagnostic I</td>
<td>Supply current, start</td>
<td>1</td>
<td>1.5</td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>I FaultI diagnostic I</td>
<td>Supply current, fault</td>
<td>2.1</td>
<td>2.8</td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>UNDER-VOLTAGE LOCKOUT</td>
<td>VDD(on) I turn-on threshold</td>
<td>19</td>
<td>21</td>
<td>23</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td>VDD(low to high)</td>
<td></td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>VS INPUT</td>
<td>V Regulating level</td>
<td>4.01</td>
<td>4.05</td>
<td>4.09</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td>Negative clamp level</td>
<td>190</td>
<td>250</td>
<td>325</td>
<td>mV</td>
</tr>
<tr>
<td></td>
<td>Input bias current</td>
<td>-0.25</td>
<td>0</td>
<td>0.25</td>
<td>µA</td>
</tr>
<tr>
<td>CS INPUT</td>
<td>V Max CS threshold voltage</td>
<td>3.7</td>
<td>715</td>
<td>750</td>
<td>775</td>
</tr>
<tr>
<td></td>
<td>Min CS threshold voltage</td>
<td>3.45</td>
<td>230</td>
<td>250</td>
<td>270</td>
</tr>
<tr>
<td></td>
<td>AM control ratio</td>
<td>2.75</td>
<td>3.0</td>
<td>3.15</td>
<td>V/V</td>
</tr>
<tr>
<td></td>
<td>constant-current regulating level</td>
<td>310</td>
<td>319</td>
<td>329</td>
<td>mV</td>
</tr>
<tr>
<td></td>
<td>Line compensating current ratio</td>
<td>23</td>
<td>25</td>
<td>28</td>
<td>A/A</td>
</tr>
<tr>
<td></td>
<td>Leading-edge blanking time</td>
<td>195</td>
<td>235</td>
<td>275</td>
<td>ns</td>
</tr>
<tr>
<td>DRV</td>
<td>DRV source current</td>
<td>8</td>
<td>20</td>
<td>25</td>
<td>mA</td>
</tr>
<tr>
<td></td>
<td>Low-side drive resistance</td>
<td>10</td>
<td>6</td>
<td>12</td>
<td>Ω</td>
</tr>
<tr>
<td></td>
<td>DRV clamp voltage</td>
<td>35</td>
<td>14</td>
<td>16</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td>DRV pull-down in start state</td>
<td>150</td>
<td>200</td>
<td>230</td>
<td>kΩ</td>
</tr>
</tbody>
</table>

(1) These devices automatically vary the control frequency and current sense thresholds to improve EMI performance, these threshold voltages and frequency limits represent average levels.
Electrical Characteristics (continued)

over operating free-air temperature range, VDD = 25 V, R_CBC = R_NTC = open, −20°C ≤ T_A ≤ 125°C, T_J = T_A
(unless otherwise noted)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>PROTECTION</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>V_OVP</td>
<td>Over-voltage threshold</td>
<td></td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>V_OCP</td>
<td>Over-current threshold</td>
<td></td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>I_{VSL}(run)</td>
<td>VS line-sense run current</td>
<td></td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>I_{VSL}(stop)</td>
<td>VS line-sense stop current</td>
<td></td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>K_{VSL}</td>
<td>VS line-sense ratio</td>
<td></td>
<td></td>
<td></td>
<td>µA/A</td>
</tr>
<tr>
<td>T_J(stop)</td>
<td>Thermal shut-down temperature</td>
<td></td>
<td></td>
<td></td>
<td>°C</td>
</tr>
</tbody>
</table>

**CABLE COMPENSATION (UCC28700 ONLY)**

<p>| | | | | | |</p>
<table>
<thead>
<tr>
<th></th>
<th></th>
<th></th>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>V_{CBC(max)}</td>
<td>Cable compensation maximum voltage</td>
<td></td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>V_{CVS(min)}</td>
<td>Compensation at VS</td>
<td></td>
<td></td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>V_{CVS(max)}</td>
<td>Maximum compensation at VS</td>
<td></td>
<td></td>
<td></td>
<td>mV</td>
</tr>
</tbody>
</table>

**CABLE COMPENSATION (UCC28701, UCC28702, AND UCC28703 ONLY)**

<p>| | | | | | |</p>
<table>
<thead>
<tr>
<th></th>
<th></th>
<th></th>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>V_{CVS}</td>
<td>Compensation at VS</td>
<td></td>
<td></td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>V_{CVS}</td>
<td>Compensation at VS</td>
<td></td>
<td></td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>V_{CVS}</td>
<td>Compensation at VS</td>
<td></td>
<td></td>
<td></td>
<td>mV</td>
</tr>
</tbody>
</table>

**NTC INPUT (UCC28701, UCC28702, AND UCC28703 ONLY)**

<p>| | | | | | |</p>
<table>
<thead>
<tr>
<th></th>
<th></th>
<th></th>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>V_{NTCTH}</td>
<td>NTC shut-down threshold</td>
<td></td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>I_{NTC}</td>
<td>NTC pull-up current</td>
<td></td>
<td></td>
<td></td>
<td>µA</td>
</tr>
</tbody>
</table>

7.6 Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>f_{SW(max)}</td>
<td>Maximum switching frequency</td>
<td></td>
<td></td>
<td></td>
<td>kHz</td>
</tr>
<tr>
<td>f_{SW(min)}</td>
<td>Minimum switching frequency</td>
<td></td>
<td></td>
<td></td>
<td>Hz</td>
</tr>
<tr>
<td>T_{ZTO}</td>
<td>Zero-crossing timeout delay</td>
<td></td>
<td></td>
<td></td>
<td>µs</td>
</tr>
</tbody>
</table>

(1) These devices automatically vary the control frequency and current sense thresholds to improve EMI performance, these threshold voltages and frequency limits represent average levels.
7.7 Typical Characteristics
At VDD = 25 V, unless otherwise noted.
Typical Characteristics (continued)

At VDD = 25 V, unless otherwise noted.

Figure 7. Minimum Switching Frequency vs. Temperature

Figure 8. DRV Source Current vs. Temperature

Figure 9. NTC Shutdown Threshold Voltage vs. Temperature

Figure 10. NTC Pullup Current vs. Temperature

Figure 11. Overvoltage Threshold vs. Temperature
8 Detailed Description

8.1 Overview

The UCC28700 is a flyback power supply controller which provides accurate voltage and constant current regulation with primary-side feedback, eliminating the need for opto-coupler feedback circuits. The controller operates in discontinuous conduction mode with valley-switching to minimize switching losses. The modulation scheme is a combination of frequency and primary peak current modulation to provide high conversion efficiency across the load range. The control law provides a wide-dynamic operating range of output power to achieve the <30-mW stand-by power requirement.

Another feature beneficial to achieve low stand-by power without excessive start-up time is a wide operating VDD range to allow a high-value VDD start-up resistance and low-value VDD capacitance. During low-power operating ranges the device has power management features to reduce the device operating current at operating frequencies below 44 kHz. The UCC28700 controller includes features in the modulator to reduce the EMI peak energy of the fundamental switching frequency and harmonics. Accurate voltage and constant current regulation, fast dynamic response, and fault protection are achieved with primary-side control. A complete charger solution can be realized with a straightforward design process, low cost and low component count.

8.2 Functional Block Diagram
8.3 Feature Description

8.3.1 Detailed Pin Description

8.3.1.1 VDD (Device Bias Voltage Supply)

The VDD pin is connected to a bypass capacitor to ground and a start-up resistance to the input bulk capacitor (+) terminal. The VDD turn-on UVLO threshold is 21 V and turn-off UVLO threshold is 8.1 V, with an available operating range up to 35 V. The USB charging specification requires the output current to operate in constant-current mode from 5 V to a minimum of 2 V; this is easily achieved with a nominal VDD of approximately 25 V. The additional VDD headroom up to 35 V allows for VDD to rise due to the leakage energy delivered to the VDD capacitor in high-load conditions. Also, the wide VDD range provides the advantage of selecting a relatively small VDD capacitor and high-value start-up resistance to minimize no-load stand-by power loss in the start-up resistor.

8.3.1.2 GND (Ground)

This is a single ground reference external to the device for the gate drive current and analog signal reference. Place the VDD bypass capacitor close to GND and VDD with short traces to minimize noise on the VS and CS signal pins.

8.3.1.3 VS (Voltage-Sense)

The VS pin is connected to a resistor divider from the auxiliary winding to ground. The output-voltage feedback information is sampled at the end of the transformer secondary current demagnetization time to provide an accurate representation of the output voltage. Timing information to achieve valley-switching and to control the duty cycle of the secondary transformer current is determined by the waveform on the VS pin. Avoid placing a filter capacitor on this input which would interfere with accurate sensing of this waveform.

The VS pin also senses the bulk capacitor voltage to provide for AC-input run and stop thresholds, and to compensate the current-sense threshold across the AC-input range. This information is sensed during the MOSFET on-time. For the AC-input run/stop function, the run threshold on VS is 220 µA and the stop threshold is 80 µA. The values for the auxiliary voltage divider upper-resistor \( R_{S1} \) and lower-resistor \( R_{S2} \) can be determined by the equations below.

\[
R_{S1} = \frac{V_{IN(run)} \times \sqrt{2}}{N_{PA} \times I_{VSL(run)}}
\]

where

- \( N_{PA} \) is the transformer primary-to-auxiliary turns ratio,
- \( V_{IN(run)} \) is the AC RMS voltage to enable turn-on of the controller (run),
- \( I_{VSL(run)} \) is the run-threshold for the current pulled out of the VS pin during the MOSFET on-time. (see the Electrical Characteristics table)

\[
R_{S2} = \frac{R_{S1} \times V_{VSR}}{N_{AS} \times (V_{OCV} + V_F) - V_{VSR}}
\]

where

- \( V_{OCV} \) is the converter regulated output voltage,
- \( V_F \) is the output rectifier forward drop at near-zero current,
- \( N_{AS} \) is the transformer auxiliary to secondary turns ratio,
- \( R_{S1} \) is the VS divider high-side resistance,
- \( V_{VSR} \) is the CV regulating level at the VS input (see the Electrical Characteristics table).
Feature Description (continued)

8.3.1.4 DRV (Gate Drive)

The DRV pin is connected to the MOSFET gate pin, usually through a series resistor. The gate driver provides a gate-drive signal limited to 14 V. The turn-on characteristic of the driver is a 25-mA current source which limits the turn-on dv/dt of the MOSFET drain and reduces the leading-edge current spike, but still provides gate-drive current to overcome the Miller plateau. The gate-drive turn-off current is determined by the low-side driver R_{DS(on)} and any external gate-drive resistance. The user can reduce the turn-off MOSFET drain dv/dt by adding external gate resistance.

8.3.1.5 CS (Current Sense)

The current-sense pin is connected through a series resistor (R_{LC}) to the current-sense resistor (R_{CS}). The current-sense threshold is 0.75 V for I_{PP(max)} and 0.25 V for I_{PP(min)}. The series resistor R_{LC} provides the function of feed-forward line compensation to eliminate change in I_{PP} due to change in di/dt and the propagation delay of the internal comparator and MOSFET turn-off time. There is an internal leading-edge blanking time of 235 ns to eliminate sensitivity to the MOSFET turn-on current spike. It should not be necessary to place a bypass capacitor on the CS pin. The value of R_{CS} is determined by the target output current in constant-current (CC) regulation. The values of R_{CS} and R_{LC} can be determined by the equations below. The term \eta_{XFMR} is intended to account for the energy stored in the transformer but not delivered to the secondary. This includes transformer resistance and core loss, bias power, and primary-to-secondary leakage ratio.

Example: With a transformer core and winding loss of 5%, primary-to-secondary leakage inductance of 3.5%, and bias power to output power ratio of 1.5%. The \eta_{XFMR} value is approximately: 1 - 0.05 - 0.035 - 0.015 = 0.9.

\[
R_{CS} = \frac{V_{CCR} \times N_{PS}}{2I_{OCC}} \times \eta_{XFMR}
\]

where
- \(V_{CCR}\) is a current regulation constant (see the Electrical Characteristics table),
- \(N_{PS}\) is the transformer primary-to-secondary turns ratio (a ratio of 13 to 15 is recommended for 5-V output),
- \(I_{OCC}\) is the target output current in constant-current regulation,
- \(\eta_{XFMR}\) is the transformer efficiency. (3)

\[
R_{LC} = \frac{K_{LC} \times R_{S1} \times R_{CS} \times T_{D} \times N_{PA}}{L_{P}}
\]

where
- \(R_{S1}\) is the VS pin high-side resistor value,
- \(R_{CS}\) is the current-sense resistor value,
- \(T_{D}\) is the current-sense delay including MOSFET turn-off delay, add ~50 ns to MOSFET delay,
- \(N_{PA}\) is the transformer primary-to-auxiliary turns ratio,
- \(L_{P}\) is the transformer primary inductance,
- \(K_{LC}\) is a current-scaling constant (see the Electrical Characteristics table). (4)

8.3.1.6 CBC (Cable Compensation), Pin 1 UCC28700

The cable compensation pin is connected to a resistor to ground to program the amount of output voltage compensation to offset cable resistance. The cable compensation block provides a 0-V to 3-V voltage level on the CBC pin corresponding to 0 to I_{OCC} output current. The resistance selected on the CBC pin programs a current mirror that is summed into the VS feedback divider therefore increasing the output voltage as I_{OUT} increases. There is an internal series resistance of 28 k\(\Omega\) to the CBC pin which sets a maximum cable compensation of a 5-V output to 400 mV when CBC is shorted to ground. The CBC resistance value can be determined by the equation below.

\[
R_{CBC} = \frac{V_{CBC(max)} \times 3 \times 1000 \times (V_{OCV} + V_{F})}{V_{VSR} \times V_{OCBC}} - 28 \text{ k}\(\Omega\)
\]
Feature Description (continued)

where

• $V_O$ is the output voltage,
• $V_F$ is the diode forward voltage,
• $V_{OCBC}$ is the target cable compensation voltage at the output terminals,
• $V_{CBC\text{ (max)}}$ is the maximum voltage at the cable compensation pin at the maximum converter output current (see the Electrical Characteristics table),
• $V_{VSR}$ is the CV regulating level at the VS input (see the Electrical Characteristics table). (5)

8.3.1.7 NTC (NTC Thermistor Shut-down), Pin 1 UCC28701/2/3

These versions of the UCC28700 family utilize pin 1 for an external NTC thermistor to allow user-programmable external thermal shut-down. The shut-down threshold is 0.95 V with an internal 105-µA current source which results in a 9.05-kΩ thermistor shut-down threshold. These controllers have either zero or fixed internal cable compensation.

8.3.2 Fault Protection

There is comprehensive fault protection incorporated into the UCC28700. Protection functions include:

• Output overvoltage
• Input undervoltage
• Internal overtemperature
• Primary overcurrent fault
• CS pin fault
• VS pin fault

A UVLO reset and restart sequence applies for all fault protection events.

The output over-voltage function is determined by the voltage feedback on the VS pin. If the voltage sample on VS exceeds 115% of the nominal $V_{OUT}$, the device stops switching and keeps the internal circuitry enabled to discharge the VDD capacitor to the UVLO turn-off threshold. After that, the device returns to the start state and a start-up sequence ensues.

The UCC28700 always operates with cycle-by-cycle primary peak current control. The normal operating range of the CS pin is 0.75 V to 0.25 V. There is additional protection if the CS pin reaches 1.5 V. This results in a UVLO reset and restart sequence. There is no leading-edge blanking on the 1.5-V threshold on CS.

The line input run and stop thresholds are determined by current information at the VS pin during the MOSFET on-time. While the VS pin is clamped close to GND during the MOSFET on-time, the current through $R_{S1}$ is monitored to determine a sample of the bulk capacitor voltage. A wide separation of run and stop thresholds allows clean start-up and shut-down of the power supply with the line voltage. The run current threshold is 220 µA and the stop current threshold is 80 µA.

The internal overtemperature protection threshold is 165°C. If the junction temperature reaches this threshold the device initiates a UVLO reset cycle. If the temperature is still high at the end of the UVLO cycle, the protection cycle repeats.

Protection is included in the event of component failures on the VS pin. If complete loss of feedback information on the VS pin occurs, the controller stops switching and restarts.

8.4 Device Functional Modes

8.4.1 Primary-Side Voltage Regulation

Figure 12 shows a simplified flyback convertor with the main voltage regulation blocks of the device shown. The power train operation is the same as any DCM flyback circuit but accurate output voltage and current sensing is the key to primary-side control.
Device Functional Modes (continued)

In primary-side control, the output voltage is sensed on the auxiliary winding during the transfer of transformer energy to the secondary. As shown in Figure 13 it is clear there is a down slope representing a decreasing total rectifier $V_F$ and resistance voltage drop $(I_S R_S)$ as the secondary current decreases to zero. To achieve an accurate representation of the secondary output voltage on the auxiliary winding, the discriminator reliably blocks the leakage inductance reset and ringing, continuously samples the auxiliary voltage during the down slope after the ringing is diminished, and captures the error signal at the time the secondary winding reaches zero current. The internal reference on VS is 4.05 V; the resistor divider is selected as outlined in the VS pin description.

The UCC28700 VS signal sampler includes signal discrimination methods to ensure an accurate sample of the output voltage from the auxiliary winding. There are however some details of the auxiliary winding signal to ensure reliable operation, specifically the reset time of the leakage inductance and the duration of any subsequent leakage inductance ring. Refer to Figure 14 for a detailed illustration of waveform criteria to ensure a reliable sample on the VS pin. The first detail to examine is the duration of the leakage inductance reset pedestal, $T_{LK\_RESET}$ in Figure 14. Because this can mimic the waveform of the secondary current decay, followed by a sharp downslope, it is important to keep the leakage reset time less than 500 ns for $I_{PRI\_MIN}$ minimum, and less than 1.5 µs for $I_{PRI\_MAX}$. The second detail is the amplitude of ringing on the $V_{AUX}$ waveform following $T_{LK\_RESET}$. The peak-to-peak voltage at the VS pin should be less than approximately 100 mVpp at least 200 ns before the end of the demagnetization time, $t_{DM}$. If there is a concern with excessive ringing, it usually occurs during light or no-load conditions, when $t_{DM}$ is at the minimum. The tolerable ripple on VS is scaled up to the auxiliary winding voltage by $R_{S1}$ and $R_{S2}$, and is equal to 100 mV x $(R_{S1} + R_{S2}) / R_{S2}$. 
During voltage regulation, the controller operates in frequency modulation mode and amplitude modulation mode as illustrated in Figure 15 below. The internal operating frequency limits of the device are 130 kHz maximum and 1 kHz minimum. The transformer primary inductance and primary peak current chosen sets the maximum operating frequency of the converter. The output preload resistor and efficiency at low power determines the converter minimum operating frequency. There is no stability compensation required for the UCC28700 controller.

8.4.2 Primary-Side Current Regulation

Timing information at the VS pin and current information at the CS pin allow accurate regulation of the secondary average current. The control law dictates that as power is increased in CV regulation and approaching CC regulation the primary-peak current is at \( I_{PP(max)} \). Referring to Figure 16 below, the primary-peak current, turns ratio, secondary demagnetization time \( T_{DM} \), and switching period \( T_{SW} \) determine the secondary average output current. Ignoring leakage inductance effects, the average output current is given by Equation 6. When the average output current reaches the regulation reference in the current control block, the controller operates in frequency modulation mode to control the output current at any output voltage at or below the voltage regulation target as long as the auxiliary winding can keep VDD above the UVLO turn-off threshold.
Device Functional Modes (continued)

![Transformer Currents Diagram]

\[ I_{OUT} = \frac{I_{PP}}{2} \times \frac{N_P}{N_S} \times \frac{t_{DM}}{T_{SW}} \]

(6)

![Typical Target Output V-I Characteristic Diagram]

8.4.3 Valley-Switching

The UCC28700 utilizes valley-switching to reduce switching losses in the MOSFET, to reduce induced-EMI, and to minimize the turn-on current spike at the sense resistor. The controller operates in valley-switching in all load conditions unless the \( V_{DS} \) ringing has diminished.

Referring to Figure 18 below, the UCC28700 operates in a valley-skipping mode in most load conditions to maintain an accurate voltage or current regulation point and still switch on the lowest available \( V_{DS} \) voltage.
Device Functional Modes (continued)

8.4.4 Start-Up Operation

Upon application of input voltage to the converter, the start-up resistor connected to VDD from the bulk capacitor voltage (V_{BLK}) charges the VDD capacitor. During charging of the VDD capacitor the device bias supply current is less than 1.5 μA. When VDD reaches the 21-V UVLO turn-on threshold, the controller is enabled and the converter starts switching. The initial three cycles are limited to I_{PP(min)}. This allows sensing any initial input or output faults with minimal power delivery. After the initial three cycles at minimum I_{PP(min)}, the controller responds to the condition dictated by the control law. The converter remains in discontinuous mode during charging of the output capacitor(s), maintaining a constant output current until the output voltage is in regulation.
9 Applications and Implementation

NOTE
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI’s customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information
The UCC2870x family of flyback power supply controllers provides constant voltage (CV) and constant current (CC) output regulation to help meet USB-compliant adaptors and charger requirements. These devices use the information obtained from auxiliary winding sensing (VS) to control the output voltage and do not require optocoupler/TL431 feedback circuitry. Not requiring optocoupler feedback reduces the component count and makes the design more cost effective.

9.2 Typical Application

![Typical Application Circuit](image)

Figure 19. Typical Application Circuit

9.2.1 Design Requirements

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>NOTES AND CONDITIONS</th>
<th>MIN</th>
<th>NOM</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>INPUT CHARACTERISTICS</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input Voltage</td>
<td>V_IN</td>
<td></td>
<td>100</td>
<td>115/230</td>
<td>240</td>
<td>V</td>
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<td>Line Frequency</td>
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<td>50/60</td>
<td>64</td>
<td>Hz</td>
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<td>No Load Input Power</td>
<td>P_SB_CONV</td>
<td>V_IN = Nom, I_O = 0A</td>
<td>30</td>
<td></td>
<td></td>
<td>mW</td>
</tr>
</tbody>
</table>

Table 1. Design Parameters
Typical Application (continued)

Table 1. Design Parameters (continued)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>NOTES AND CONDITIONS</th>
<th>MIN</th>
<th>NOM</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>Brownout Voltage</td>
<td>$V_{IN(RUN)}$</td>
<td>$I_O = \text{Nom}$</td>
<td>70</td>
<td></td>
<td></td>
<td>V</td>
</tr>
</tbody>
</table>

**OUTPUT CHARACTERISTICS**

| Output Voltage         | $V_O$  | $V_{IN} = \text{Nom}, I_O = \text{Nom}$ | 4.75 | 5    | 5.25 | V    |
| Output Voltage Ripple  | $V_{RIPPLE}$ | $V_{IN} = \text{Nom}, I_O = \text{Max}$ | 0.1  |      |      | V    |
| Output Current         | $I_O$  | $V_{IN} = \text{Min to Max}$            | 1    | 1.05 |      | A    |
| Output OVP             | $V_{OVP}$ | $I_{OUT} = \text{Min to Max}$           | 5.75 |      |      | V    |
| Transient Response     | $V_{O\Delta}$ | $(0.1 \text{ to } 0.6 \text{ A}) \text{ or } (0.6 \text{ to } 0.1 \text{ A})$ | 4.1  | 5    | 6    | A    |

**SYSTEMS CHARACTERISTICS**

| Switching Frequency    | $f$    | $I_O = 1 \text{ A}$ | 74%  | 76%  |      |      |

9.2.2 Detailed Design Procedure

This procedure outlines the steps to design a constant-voltage, constant-current flyback converter using the UCC28700 family of controllers. Please refer to the Figure 19 for circuit details and section Device Nomenclature for variable definitions used in the applications equations below.

9.2.2.1 Transformer Parameter Verification

The transformer turns ratio selected affects the MOSFET $V_{DS}$ and secondary rectifier reverse voltage so these should be reviewed. The UCC28700 controller requires a minimum on time of the MOSFET ($T_{ON}$) and minimum $D_{MAG}$ time ($T_{DMAG}$) of the secondary rectifier in the high line, minimum load condition. The selection of $F_{MAX}$, $L_P$ and $R_{CS}$ affects the minimum $T_{ON}$ and $T_{DMAG}$.

The secondary rectifier and MOSFET voltage stress can be determined by the equations below.

$$V_{REV} = \frac{V_{IN(max)} \times \sqrt{2}}{N_{PS}} + V_{OCV} + V_{OCBC}$$  \hspace{1cm} (7)

For the MOSFET $V_{DS}$ voltage stress, an estimated leakage inductance voltage spike ($V_{LK}$) needs to be included.

$$V_{DSPK} = \left(\frac{V_{IN(max)} \times \sqrt{2}}{N_{PS}}\right) + \left(V_{OCV} + V_f + V_{OCBC}\right) \times N_{PS} + V_{LK}$$  \hspace{1cm} (8)

The following equations are used to determine if the minimum $T_{ON}$ target of 300 ns and minimum $T_{DMAG}$ target of 1.1 µs is achieved.

$$T_{ON(min)} = \frac{L_P}{V_{IN(max)} \times \sqrt{2}} \times \frac{I_{PP(max)} \times V_{CST(min)}}{V_{CST(max)}}$$  \hspace{1cm} (9)

$$T_{DMAG(min)} = \frac{T_{ON(min)} \times V_{IN(max)} \times \sqrt{2}}{N_{PS} \times (V_{OCV} + V_f)}$$  \hspace{1cm} (10)

9.2.2.2 Output Capacitance

The output capacitance value is typically determined by the transient response requirement from no-load. For example, in some USB charger applications there is a requirement to maintain a minimum $V_D$ of 4.1 V with a load-step transient of 0 mA to 500 mA. The equation below assumes that the switching frequency can be at the UCC28700 minimum of $f_{SW\text{min}}$. 

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Product Folder Links: UCC28700 UCC28701 UCC28702 UCC28703
Another consideration of the output capacitor(s) is the ripple voltage requirement which is reviewed based on secondary peak current and ESR. A margin of 20% is added to the capacitor ESR requirement in the equation below.

$$R_{ESR} = \frac{V_{RIPPLE} \times 0.8}{I_{PP(max)} \times N_{PS}}$$

(12)

9.2.2.3 VDD Capacitance, $C_{DD}$

The capacitance on VDD needs to supply the device operating current until the output of the converter reaches the target minimum operating voltage in constant-current regulation. At this time the auxiliary winding can sustain the voltage to the UCC28700. The total output current available to the load and to charge the output capacitors is the constant-current regulation target. The equation below assumes the output current of the flyback is available to charge the output capacitance until the minimum output voltage is achieved. There is an estimated 1 mA of gate-drive current in the equation and 1 V of margin added to VDD.

$$C_{DD} = \frac{(I_{RUN} + 1 mA) \times C_{OUT} \times V_{OCC}}{(V_{DD(on)} - V_{DD(off)}) - 1 V}$$

(13)

9.2.2.4 VDD Start-Up Resistance, $R_{STR}$

Once the VDD capacitance is known, the start-up resistance from $V_{BULK}$ to achieve the turn-on time target can be determined.

$$R_{STR} = \frac{\sqrt{2} \times V_{IN(min)}}{I_{START} + \frac{V_{DD(on)} \times C_{DD}}{T_{STR}}}$$

(14)

9.2.2.5 VS Resistor Divider, Line Compensation, and Cable Compensation

The VS divider resistors determine the output voltage regulation point of the flyback converter, also the high-side divider resistor ($R_{S1}$) determines the line voltage at which the controller enables continuous DRV operation. $R_{S1}$ is initially determined based on transformer auxiliary to primary turns ratio and desired input voltage operating threshold.

$$R_{S1} = \frac{V_{IN(run)} \times \sqrt{2}}{N_{PA} \times I_{VSL(run)}}$$

(15)

The low-side VS pin resistor is selected based on desired $V_O$ regulation voltage.

$$R_{S2} = \frac{R_{S1} \times V_{VSR}}{N_{AS} \times (V_{OCV} + V_F) - V_{VSR}}$$

(16)

The UCC28700 can maintain tight constant-current regulation over input line by utilizing the line compensation feature. The line compensation resistor ($R_{LC}$) value is determined by current flowing in $R_{S1}$ and expected gate drive and MOSFET turn-off delay. Assume a 50-ns internal delay in the UCC28700.

$$R_{LC} = \frac{K_{LC} \times R_{S1} \times R_{CS} \times T_D \times N_{PA}}{L_p}$$

(17)
On the UCC28700 which has adjustable cable compensation, the resistance for the desired compensation level at the output terminals can be determined using the equation below.

\[
R_{\text{CBC}} = \frac{V_{\text{CBC(max)}} \times 3 \, \text{k}\Omega \times (V_{\text{OCV}} + V_F)}{V_{\text{VSR}} \times V_{\text{OCBC}}} - 28 \, \text{k}\Omega
\]  

(18)

9.2.2.6 Input Bulk Capacitance and Minimum Bulk Voltage

Determine the minimum voltage on the input capacitance, \(C_{B1}\) and \(C_{B2}\) total, in order to determine the maximum \(N_p\) to \(N_s\) turns ratio of the transformer. The input power of the converter based on target full-load efficiency, minimum input RMS voltage, and minimum AC input frequency are used to determine the input capacitance requirement.

Maximum input power is determined based on \(V_{\text{OCV}}\), \(I_{\text{OCC}}\), and the full-load efficiency target.

\[
P_{\text{IN}} = \frac{V_{\text{OCV}} \times I_{\text{OCC}}}{\eta}
\]

(19)

The below equation provides an accurate solution for input capacitance based on a target minimum bulk capacitor voltage. To target a given input capacitance value, iterate the minimum capacitor voltage to achieve the target capacitance.

\[
C_{\text{BULK}} = \frac{2P_{\text{IN}} \times \left[0.25 + \frac{1}{2\pi} \times \arcsin\left(\frac{V_{\text{BULK(min)}}}{\sqrt{2 \times V_{\text{IN(min)}}}}\right)\right]}{\left[2V_{\text{IN(min)}}^2 - V_{\text{BULK(min)}}^2\right] \times f_{\text{LINE}}}
\]

(20)

9.2.2.7 Transformer Turns Ratio, Inductance, Primary-Peak Current

The maximum primary-to-secondary turns ratio can be determined by the target maximum switching frequency at full load, the minimum input capacitor bulk voltage, and the estimated DCM quasi-resonant time.

Initially determine the maximum available total duty cycle of the on time and secondary conduction time based on target switching frequency and DCM resonant time. For DCM resonant time, assume 500 kHz if you do not have an estimate from previous designs. For the transition mode operation limit, the period required from the end of secondary current conduction to the first valley of the \(V_{\text{DS}}\) voltage is \(\frac{1}{2}\) of the DCM resonant period, or 1 µs assuming 500-kHz resonant frequency. \(D_{\text{MAX}}\) can be determined using the equation below.

\[
D_{\text{MAX}} = 1 - \left(\frac{T_R}{2} \times f_{\text{MAX}}\right) - D_{\text{MAGCC}}
\]

(21)

Once \(D_{\text{MAX}}\) is known, the maximum turns ratio of the primary to secondary can be determined with the equation below. \(D_{\text{MAGCC}}\) is defined as the secondary diode conduction duty cycle during constant-current, CC, operation. It is set internally by the UCC28700 at 0.425. The total voltage on the secondary winding needs to be determined; which is the sum of \(V_{\text{OCV}}\), the secondary rectifier \(V_F\), and the cable compensation voltage (\(V_{\text{OCBC}}\)). For the 5-V USB charger applications, a turns ratio range of 13 to 15 is typically used.

\[
N_{\text{PS(max)}} = \frac{D_{\text{MAX}} \times V_{\text{BULK(min)}}}{D_{\text{MAGCC}} \times (V_{\text{OCV}} + V_F + V_{\text{OCBC}})}
\]

(22)

Once an optimum turns ratio is determined from a detailed transformer design, use this ratio for the following parameters.

The UCC28700 controller constant-current regulation is achieved by maintaining a maximum \(D_{\text{MAG}}\) duty cycle of 0.425 at the maximum primary current setting. The transformer turns ratio and constant-current regulating voltage determine the current sense resistor for a target constant current.
Since not all of the energy stored in the transformer is transferred to the secondary, a transformer efficiency term is included. This efficiency number includes the core and winding losses, leakage inductance ratio, and bias power ratio to rated output power. For a 5-V, 1-A charger example, bias power of 1.5% is a good estimate. An overall transformer efficiency of 0.9 is a good estimate to include 3.5% leakage inductance, 5% core and winding loss, and 1.5% bias power.

\[ R_{CS} = \frac{V_{CCR} \times N_{PS}}{2I_{OCC}} \times n_{XFMR} \]  

(23)

The primary transformer inductance can be calculated using the standard energy storage equation for flyback transformers. Primary current, maximum switching frequency and output and transformer power losses are included in the equation below. Initially determine transformer primary current.

Primary current is simply the maximum current sense threshold divided by the current sense resistance.

\[ I_{PP(max)} = \frac{V_{CST(max)}}{R_{CS}} \]  

(24)

\[ L_p = \frac{2(V_{OCV} + V_F + V_{OCBC}) \times I_{OCC}}{n_{XFMR} \times I_{PP(max)} \times f_{MAX}} \]  

(25)

The secondary winding to auxiliary winding transformer turns ratio (N_{AS}) is determined by the lowest target operating output voltage in constant-current regulation and the VDD UVLO of the UCC28700. There is additional energy supplied to VDD from the transformer leakage inductance energy which allows a lower turns ratio to be used in many designs.

\[ N_{AS} = \frac{V_{DD(off)} + V_{FA}}{V_{OCC} + V_F} \]  

(26)

9.2.2.8 Standby Power Estimate

Assuming no-load standby power is a critical design parameter, determine estimated no-load power based on target converter maximum switching frequency and output power rating.

The following equation estimates the stand-by power of the converter.

\[ P_{SB\_CONV} = \frac{P_{OUT} \times f_{MIN}}{n_{SB} \times K_{AM} \times f_{MAX}} \]  

(27)

For a typical USB charger application, the bias power during no-load is approximately 2.5 mW. This is based on 25-V VDD and 100-µA bias current. The output preload resistor can be estimated by V_{OCV} and the difference in the converter stand-by power and the bias power. The equation for output preload resistance accounts for bias power estimated at 2.5 mW.

\[ R_{PL} = \frac{V_{OCV}^2}{P_{SB\_CONV} - 2.5 \text{ mW}} \]  

(28)

Typical start-up resistance values for R_{STR} range from 13 MΩ to 20 MΩ to achieve 1-s start-up time. The capacitor bulk voltage for the loss estimation is the highest voltage for the stand-by power measurement, typically 325 V_{DC}.

\[ P_{RSTR} = \frac{V_{BLK}^2}{R_{STR}} \]  

(29)

For the total stand-by power estimation add an estimated 2.5 mW for snubber loss to the start-up resistance and converter stand-by power loss.

\[ P_{SB} = P_{SB\_CONV} + P_{RSTR} + 2.5 \text{ mW} \]  

(30)
9.2.3 Application Curves

![Figure 20. Efficiency](image1)

![Figure 21. Output at Startup at 115-V RMS (No Load)](image2)

![Figure 22. Output at Startup at 115-V RMS (5-Ω Load)](image3)

![Figure 23. Output at Startup at 230-V RMS (No Load)](image4)

![Figure 24. Output at Startup at 230-V RMS (5-Ω Load)](image5)

![Figure 25. Load Transients: (0.1-A to 0.6-A Load Step)](image6)
CH1 = I_o, CH4 = V_o With a 5-V Offset

CH1 5.00mV CH4 2.00mV
100mV 100mV
M10.0ms CH1 2.2ms
16 May 2012 15:40:17

Figure 26. Load Transients:
(0.6-A to 0.1-A Load Step)

CH4 = V_o, Output voltage at EVM output
CH2 = V_o, Output voltage measured at the end of the 3M of
cable in parallel with a 1-uF capacitor. The output voltage has
less than 50 mV of output ripple at the end of the cable.

Figure 27. Output Ripple Voltage at Full Load
10 Power Supply Recommendations

The UCC2870X family is intended for AC/DC adapters and chargers with input voltage range of 85 V_{AC(rms)} to 265 V_{AC(rms)} using Flyback topology. It can be used in other applications and converter topologies with different input voltages. Be sure that all voltages and currents are within the recommended operating conditions and absolute maximum ratings of the device.

To maintain output current regulation over the entire input voltage range, design the converter to operate close to \( f_{\text{MAX}} \) when in full-load conditions.

To improve thermal performance increase the copper area connected to GND pins.

11 Layout

11.1 Layout Guidelines

- High frequency bypass Capacitor C7 should be placed arcs Pin 2 and 5 as close as you can get it to the pins.
- Resistor R15 and C7 form a low pass filter and the connection of R15 and C7 should be as close to the VDD pin as possible.
- C9 should be put as close to CS pin and R10 as possible. This forms a low pass filter with R10.
- The connection for C9 and R10 should be as close to the CS pin as possible.
- Please note that C9 may not be required in all designs. However, it is wise to put a place holder for it in your design.
- The VS pin controls the output voltage through the transformer turns ratio and the voltage divider of R7 and R9. Note the trace with between the R7, R9 and VS pin should be; as short as; possible to reduce/eliminate possible EMI coupling.
- Note the IC ground and power ground should meet at the bulk capacitor’s (C4 and C5) return. Tri to ensure that high frequency/high current from the power stage does not go through the signal ground.
- The high frequency/high current path that you need to be cautious of on the primary is C4, C5 +, T1 (P1,P2), Q1d, Q1s, R13 to the return of C4 and C5.

Figure 28. 5W USB Adapter Schematic
Layout Guidelines (continued)

- Try to keep all high current loops as short as possible.
- Keep all high current/high frequency traces away from or perpendicular to other traces in the design.
- Traces on the voltage clamp formed by D1, R1, D4 and C4 as short as possible.
- C4 return needs to be as close to the bulk capacitor supply as possible. This reduces the magnitude of $dv/dt$ caused by large $di/dt$.
- Avoid mounting semiconductors under magnetics.

11.2 Layout Example

![Layout Example Diagram]

Figure 29. Layout Example

12 Device and Documentation Support

12.1 Device Support

12.1.1 Device Nomenclature

12.1.1.1 Capacitance Terms in Farads

- $C_{BULK}$: total input capacitance of $C_{B1}$ and $C_{B2}$.
- $C_{DD}$: minimum required capacitance on the VDD pin.
- $C_{OUT}$: minimum output capacitance required.

12.1.1.2 Duty Cycle Terms

- $D_{MAGCC}$: secondary diode conduction duty cycle in CC, 0.425.
- $D_{MAX}$: MOSFET on-time duty cycle.

12.1.1.3 Frequency Terms in Hertz

- $f_{LINE}$: minimum line frequency.
- $f_{MAX}$: target full-load maximum switching frequency of the converter.
- $f_{MIN}$: minimum switching frequency of the converter, add 15% margin over the $f_{SW(min)}$ limit of the device.
- $f_{SW(min)}$: minimum switching frequency (see the Electrical Characteristics table)
Device Support (continued)

12.1.1.4 Current Terms in Amperes

I_{OCC} converter output constant-current target.
I_{PP(max)} maximum transformer primary current.
I_{START} start-up bias supply current (see the Electrical Characteristics table).
I_{TRAN} required positive load-step current.
I_{VSL(run)} VS pin run current (see the Electrical Characteristics table).

12.1.1.5 Current and Voltage Scaling Terms

K_{AM} maximum-to-minimum peak primary current ratio (see the Electrical Characteristics table).
K_{LC} current-scaling constant (see the Electrical Characteristics table).

12.1.1.6 Transformer Terms

L_P transformer primary inductance.
N_{AS} transformer auxiliary-to-secondary turns ratio.
N_{PA} transformer primary-to-auxiliary turns ratio.
N_{PS} transformer primary-to-secondary turns ratio.

12.1.1.7 Power Terms in Watts

P_{IN} converter maximum input power.
P_{OUT} full-load output power of the converter.
P_{RSTR} VDD start-up resistor power dissipation.
P_{SB} total stand-by power.
P_{SB_CONV} P_{SB} minus start-up resistor and snubber losses.

12.1.1.8 Resistance Terms in Ω

R_{CS} primary current programming resistance.
R_{ESR} total ESR of the output capacitor(s).
R_{PL} preload resistance on the output of the converter.
R_{S1} high-side VS pin resistance.
R_{S2} low-side VS pin resistance.
R_{STR} maximum start-up resistance to achieve the turn-on time target.
R_{STR VDD} V_{DD} start-up resistance.

12.1.1.9 Timing Terms in Seconds

T_D current-sense delay including MOSFET turn-off delay; add 50 ns to MOSFET delay.
T_{DMAG(min)} minimum secondary rectifier conduction time.
T_{ON(min)} minimum MOSFET on time.
T_R resonant frequency during the DCM (discontinuous conduction mode) time.
T_{STR} converter start-up time requirement.

12.1.1.10 Voltage Terms in Volts

V_{BLK} highest bulk capacitor voltage for stand-by power measurement.
Device Support (continued)

- $V_{BULK(min)}$: minimum voltage on $C_{B1}$ and $C_{B2}$ at full power.
- $V_{OCBC}$: target cable compensation voltage at the output terminals.
- $V_{CBC(max)}$: maximum voltage at the CBC pin at the maximum converter output current (see the Electrical Characteristics table).
- $V_{CCR}$: constant-current regulating voltage (see the Electrical Characteristics table).
- $V_{CST(max)}$: CS pin maximum current-sense threshold (see the Electrical Characteristics table).
- $V_{CST(min)}$: CS pin minimum current-sense threshold (see the Electrical Characteristics table).
- $V_{DD(off)}$: UVLO turn-off voltage (see the Electrical Characteristics table).
- $V_{DD(on)}$: UVLO turn-on voltage (see the Electrical Characteristics table).
- $V_{OΔ}$: output voltage drop allowed during the load-step transient.
- $V_{DSPK}$: peak MOSFET drain-to-source voltage at high line.
- $V_F$: secondary rectifier forward voltage drop at near-zero current.
- $V_{FA}$: auxiliary rectifier forward voltage drop.
- $V_{LK}$: estimated leakage inductance energy reset voltage.
- $V_{OCV}$: regulated output voltage of the converter.
- $V_{OCC}$: target lowest converter output voltage in constant-current regulation.
- $V_{REV}$: peak reverse voltage on the secondary rectifier.
- $V_{RIPPLE}$: output peak-to-peak ripple voltage at full-load.
- $V_{VSR}$: CV regulating level at the VS input (see the Electrical Characteristics table).

12.1.1.11 AC Voltage Terms in $V_{RMS}$

- $V_{IN(max)}$: maximum input voltage to the converter.
- $V_{IN(min)}$: minimum input voltage to the converter.
- $V_{IN(run)}$: converter input start-up (run) voltage.

12.1.1.12 Efficiency Terms

- $\eta_{SB}$: estimated efficiency of the converter at no-load condition, not including start-up resistance or bias losses. For a 5-V USB charger application, 60% to 65% is a good initial estimate.
- $\eta$: converter overall efficiency.
- $\eta_{XFMR}$: transformer primary-to-secondary power transfer efficiency.

12.2 Documentation Support

12.2.1 Related Documentation

For related documentation see the following:

Using the UCC28700EVM-068, Evaluation Module, SLUU968

12.2.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.
12.3 Trademarks
All trademarks are the property of their respective owners.

12.4 Electrostatic Discharge Caution

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.
### PACKAGING INFORMATION

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<th>Package Qty</th>
<th>Eco Plan</th>
<th>Lead/Ball Finish</th>
<th>MSL Peak Temp</th>
<th>Op Temp (°C)</th>
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(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF UCC28700:**

- Automotive: UCC28700-Q1

**NOTE:** Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
**TAPE AND REEL INFORMATION**

*All dimensions are nominal.*

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**TAPE DIMENSIONS**

- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- K0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P1: Pitch between successive cavity centers

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**

- Q1, Q2, Q3, Q4: Pocket Quadrants
- Sprocket Holes
- User Direction of Feed

**PACKAGE MATERIALS INFORMATION**

**TAPE AND REEL BOX DIMENSIONS**

*All dimensions are nominal*

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NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
4. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
5. Reference JEDEC MO-178.
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.
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